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Http://www.ledtech.com.tw

SPECIFICATION

PART NO.: LT1862-RGB-D54-SC4
5.0mm ROUND FULL-COLOR LAMP(4LEADS)

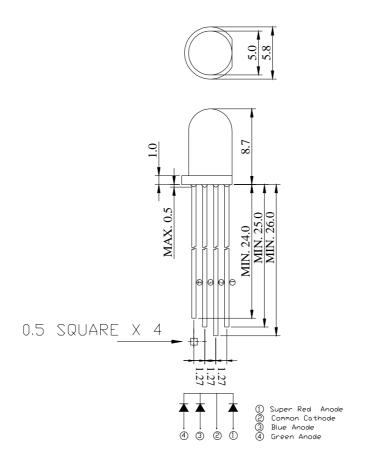




Approved by	Checked by	Prepared by
Yang	Lian	Haibo

Description

This RGB full color lamp is made with AlGaInP red chip,InGaN/Sapphire green chip, InGaN/Sapphire blue chip and white diffused epoxy resin.



Notes:

- 1. All dimensions are in mm.
- 2. Tolerance is \pm 0.25mm unless otherwise noted.

Description

	LED (
Part No.	Material	Emitting Color	Lens Color
	AlGaInP	Super red	
LT1862-RGB-D54-SC4	InGaN/Sapphire	Green	White diffused
	InGaN/Sapphire	Blue	

VER.: 01 Date: 2021/09/26 Page: 1/5

LT1862-RGB-D54-SC4

Absolute Maximum Ratings at Ta=25°℃

Parameter	Symbol	Rating U		Unit
		R	72	
Power Dissipation	PD	G	108	mW
		В	108	
Reverse Voltage	VR	5		
D.C. Forward Current	If	30 1		mA
Peak Current(1/10Duty Cycle,0.1ms Pulse Width.)	If(Peak)	100 m		mA
Operating Temperature Range	Topr	-25 to +85		$^{\circ}\mathbb{C}$
Storage Temperature Range	Tstg	-40 to +100		$^{\circ}\mathbb{C}$
Soldering Tomporeture (1 6mm from hody)	Tsol	Dip Soldering : 260°C for 5 sec.		
Soldering Temperature(1.6mm from body)		Hand Soldering : 350°C for 3 sec.		
Electrostatic discharge	ESD		1000	V

Electrical and Optical Characteristics:

Parameter	Symbol	Condition	Color	Min.	Тур.	Max.	Unit
			R	110	250		
Luminous Intensity	Iv	If=20mA	G	500	1250		mcd
			В	200	450		
			R		1.9	2.4	
Forward Voltage	Vf	If=20mA	G		3.2	3.6	V
			В		3.2	3.6	
			R		639		
Peak Wavelength	λр	If=20mA	G				nm
			В]
			R		630		
Dominant Wavelength	λd	If=20mA	G		520		nm
			В		465		
Reverse (Leakage) Current	Ir	Vr=5V				50	μΑ
Viewing Angle	2 0 1/2	If=20mA			40		deg
			R		20		
Spectrum Line Halfwidth	$\Delta \lambda$	If=20mA	G		35		nm
			В		26		

Notes: 1. Tolerance of Luminous Intensity is $\pm 15\%$

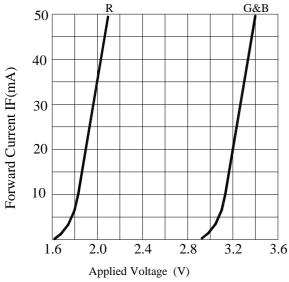
2. Tolerance of Forward Voltage is ± 0.1 V

3. Tolerance of Dominant Wavelength is ± 1 nm

VER.: 01 Date: 2021/09/26 Page: 2/5



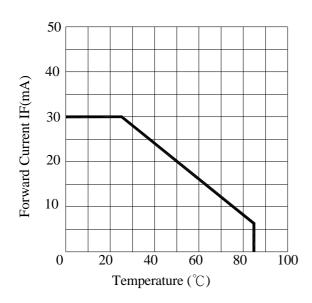
Typical Electrical / Optical Characteristics Curves:

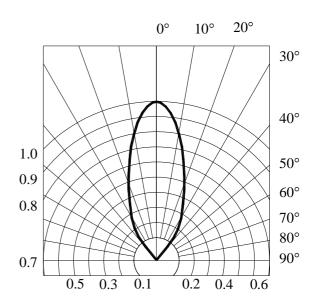


1500 Green | 1200 | Green | 1200 | Blue | Red | Red | Red | Red | Red | Green | Green

FORWARD CURRENT VS.APPLIED VOLTAGE







FORWARD CURRENT VS. AMBIENT TEMPERATURE

RADIATION DIAGRAM

VER.: 01 Date: 2021/09/26 Page: 3/5



LT1862-RGB-D54-SC4

5.0mm ROUND FULL-C OLOR LAMP(4LEADS)

Precautions:

TAKE NOTE OF THE FOLLOWING IN USE OF LED

1. Temperature in use

Since the light generated inside the LED needs to be emitted to outside efficiently, a resin with high light transparency is used; therefore, additives to improve the heat resistance or moisture resistance (silica gel, etc) which are used for semiconductor products such as transistors cannot be added to the resin. Consequently, the heat resistant ability of the resin used for LED is usually low; therefore, please be careful on the following during use. Avoid applying external force, stress, and excessive vibration to the resins and terminals at high temperature. The glass transition temperature of epoxy resin used for the LED is approximately 120-130°C. At a temperature exceeding this limit, the coefficient of liner expansion of the resin doubles or more compared to that at normal temperature and the resin is softened. If external force or stress is applied at that time, it may cause a wire rupture.

2. Soldering

Please be careful on the following at soldering.

After soldering, avoided applying external force, stress, and excessive vibration until the products go to cooling process (normal temperature), <Same for products with terminal leads>

(1) Soldering measurements:

Distance between melted solder side to bottom of resin shall be 1.6mm or longer.

(2) Dip soldering:

Pre-heat: 90°C max. (Backside of PCB), Within 60 seconds.

Solder bath: 260±5°C (Solder temperature), Within 5 seconds.

(3) Hand soldering: 350°C max. (Temperature of soldering iron tip), Within 3 seconds.

3. Insertion

Pitch of the LED leads and pitch of mounting holes need to be same.

4. Others

Since the heat resistant ability of the LED resin is low, SMD components are used on the same PCB, please mount the LED after adhesive baking process for SMD components. In case adhesive baking is done after LED lamp insertion due to a production process reason, make sure not to apply external force, stress, and excessive vibration to the LED and follow the conditions below. Baking temperature: 120°C max. Baking time: Within 60 seconds. If soldering is done sequentially after the adhesive baking, please perform the soldering after cooling down the LED to normal temperature.

5. This LED is designed to be wave solder and dip soldered on to a PCB. If reflow soldered, Ledtech cannot guarantee its reliability.

Disclaimer

- 1. Our department reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets our department published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. Our department assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 5. These specification sheets include materials protected under copyright of our department. Reproduction in any form is prohibited without obtaining our department's prior consent.

This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized our department sales agent for special application request.

VER.: 01 Date: 2021/09/26 Page: 4/5



LT1862-RGB-D54-SC4

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ENCASED TYPE



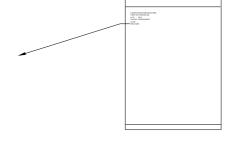
LEDTECH ELECTRONICS CORP.

PART NO:LTXXXX-XX

Q'TY : PCS

LOT NO :XXXXXXXXX

DATE : BIN CODE:

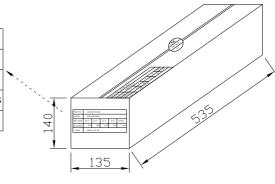


INNER BOX

QUANTITY: 15 PACKETS

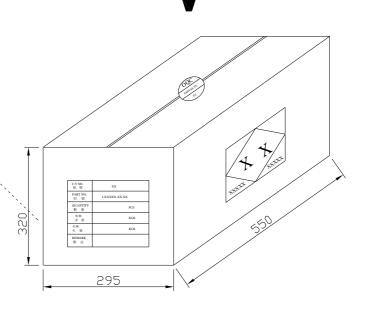
TOTAL: 7,500 PCS

PART NO.	LXXXXX-XX-XX				
LOT NO.	xxxxxxxxx				
BIN CODE	Xx X	Xx X	Xx X	Xx X	TOTAL
QUANTITY	PCS	PCS	PCS	PCS	PCS
DATE	XXXX	, XX , XX	ζ.		



OUTER CARTON QUANTITY: 4 BOX TOTAL: 30,000 PCS

C/T NO. 箱 號	xx
PART NO. 料 號	LXXXXX-XX-XX
QUANTITY 數 量	PCS
N.W. 净 重	KGS
G.W. 毛 重	KGS
REMARK 備 註	



VER.: 01 Date: 2021/09/26 Page: 5/5